

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
MICHAEL JOSEPH MCPARTLIN	01/09/2017
BHARATJEET SINGH GILL	01/09/2017
RECEIVING PARTY DATA	
Name:	Skyworks Solutions, Inc.
Street Address:	20 Sylvan Road
City:	Woburn
State/Country:	MASSACHUSETTS
Postal Code:	01801
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	15299760
CORRESPONDENCE DATA	
Fax Number:	(949)231-3206
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	9492313073
Email:	ip.docketing@skyworksinc.com
Correspondent Name:	DONALD BOLLELLA
Address Line 1:	5221 CALIFORNIA AVENUE, 21-1
Address Line 4:	IRVINE, CALIFORNIA 92617
ATTORNEY DOCKET NUMBER:	16SKY0386.02 US
NAME OF SUBMITTER:	DONALD BOLLELLA
SIGNATURE:	/Donald Bollella/
DATE SIGNED:	02/04/2017
Total Attachments: 2	
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ASSIGNMENT

WHEREAS, we, Michael Joseph McPartlin residing at 99 Meadowview Road, North Andover, Massachusetts 01845 and Bharatjeet Singh Gill residing at 140 Strathcarron Crescent, Ottawa, Ontario K2K 0C8, Canada, have invented a certain new and useful SOLDER BUMP PLACEMENT FOR THERMAL MANAGEMENT IN FLIP CHIP AMPLIFIERS for which we have made application for Letters Patent of the United States as fully set forth and described in the specification duly filed in the United States Patent and Trademark Office on October 21, 2016 and assigned Application Serial No. 15/299,760, which derived priority benefit from U.S. Provisional Patent Application Serial No. 62/245,183 filed October 22, 2015 and U.S. Provisional Patent Application Serial No. 62/245,168 filed October 22, 2015; and

WHEREAS, Skyworks Solutions, Inc., a corporation duly organized and existing under and by virtue of the laws of the State of Delaware, having a principal business address at 20 Sylvan Road, Woburn, Massachusetts 01801, is desirous of acquiring the entire interest in and to said invention, said non-provisional and provisional applications, any and all inventions and improvements disclosed in said applications, and all Letters Patent to be had therefor.

NOW THEREFORE, to all whom it may concern, be it known, that for good and valuable consideration, the sufficiency and receipt of which are hereby acknowledged, we, said Michael Joseph McPartlin and Bharatjeet Singh Gill have sold, assigned, transferred, and set over, and by these presents do sell, assign, transfer, and set over unto said Skyworks Solutions, Inc., the whole right, title, and interest in and to said SOLDER BUMP PLACEMENT FOR THERMAL MANAGEMENT IN FLIP CHIP AMPLIFIERS, the aforesaid applications, and any and all inventions and improvements disclosed in the aforesaid non-provisional and provisional applications for patent, as fully set forth and described therein, and all divisional, continuing, substitute, renewal, reissue, and all other applications for Letters Patent derived from or claiming priority to the aforesaid applications which have been or shall be filed in the United States and in and to the United States Letters Patent to be issued thereon for the territory of the United States, and all corresponding foreign counterpart applications derived from or claiming priority to the aforesaid United States non-provisional and provisional patent applications and related applications as prepared for and filed in any and all foreign countries, said whole right, title, and interest being the same for said Skyworks Solutions, Inc.'s own use and for the use of its assigns, successors, and legal representatives to the full end of the term for which all said Letters Patent may be granted, as fully and entirely as the same would have been held and enjoyed by us had this assignment and sale not been made. And we hereby acknowledge, agree, and understand that this assignment conveys any and all other related intellectual property rights including, but not so limited to, copyright rights, copyrightable subject matter, know how, trade secrets, copyright registrations, and reproduction rights, including any and all right to sue for past, current, or future infringement of the intellectual property rights hereby sold, assigned, and transferred, and we further hereby waive any and all moral rights under 17 U.S.C. § 106A or as so otherwise provided.

And we, for ourselves, our heirs, assigns, and legal representatives hereby covenant to and with said assignee Skyworks Solutions, Inc., its assigns, successors, and legal representatives, that we have full right to sell, assign, and transfer the whole right, title, and interest in and to said inventions and improvements, said non-provisional and provisional applications, and all the Letters Patent to be had therefor and that the entire interest herein conveyed is free from all prior assignment, grant, mortgage, license, or other encumbrance whatsoever. And we also, for ourselves, our heirs, assigns, and legal representatives hereby further covenant to and with said assignee Skyworks Solutions, Inc., its assigns, successors, and legal representatives to fully

cooperate therewith in the prosecution of the aforesaid applications in the United States Patent and Trademark Office and in any and all foreign jurisdictions, said cooperation extending to any U.S. or foreign divisional, continuing, substitute, renewal, reissue, or any other application derived from or claiming priority to the aforesaid applications, and including the execution of additional declarations, assignments, and other formal documents as may be required in connection therewith.

And we do hereby covenant and agree not to challenge or oppose, on any grounds whatsoever, the validity of this assignment or to assist or request any third party to contest the validity of this assignment, and we further agree not to contest the validity or enforceability of any intellectual property rights assigned herein, or to assist or request any third party to contest the validity or enforceability of any intellectual property rights assigned herein. And we also agree that no course of conduct or dealing by us shall act as an amendment, modification, or waiver of any provision of this assignment unless specifically set forth in writing.

And we do hereby authorize and request the United States Commissioner of Patents to issue Letters Patent to said Skyworks Solutions, Inc. as the assignee of our entire right, title, and interest therein.

IN TESTIMONY WHEREOF, we have hereunto set our respective hand and seal on the day and month as indicated below.

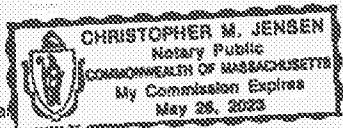
Michael J. McPartlin L.S.
Michael Joseph McPartlin

Date: January 9, 2017

Acknowledgment

Commonwealth of Massachusetts)
County of Essex) ss.

On this 9th day of January, 2017 before me, the undersigned notary public, personally appeared Michael Joseph McPartlin, proved to me through satisfactory evidence of identification, which was DM Driver License, to be the person whose name is signed on the preceding Assignment, and acknowledged to me that he signed it voluntarily for its stated purpose.



Christopher M. Jensen
(Official Signature of Notary)
Christopher M. Jensen Notary Public
(Notary's printed or typed name)

Bharatjeet Singh Gill L.S.
Bharatjeet Singh Gill

Date: Jan. 9, 2017

Acknowledgment
Commonwealth of Massachusetts
(Canada, Province of Ontario)
County of Essex) ss.
City of Geauga)

On this 9th day of January, 2017 before me, Christopher M. Jensen, Notary Public, personally appeared Bharatjeet Singh Gill, proved to me on the basis of satisfactory evidence to be the person whose name is subscribed to the within instrument and acknowledged to me that he executed the same in his authorized capacity, and that by his signature on the instrument the person, or the entity upon behalf of which the person acted, executed the instrument.

WITNESS my hand and official seal.

Christopher M. Jensen
(Signature of Notary)
Christopher M. Jensen

